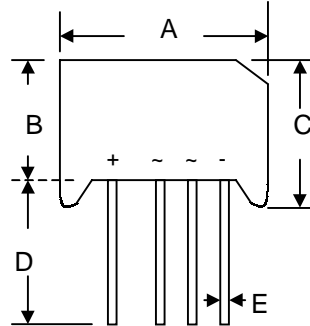
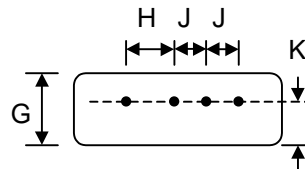


### Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards



RS-5		
Dim	Min	Max
A	39.40	40.10
B	20.20	21.00
C	21.00	21.70
D	25.40	—
E	0.97 Ø	1.07 Ø
G	6.20	6.70
H	9.80	10.20
J	7.20	7.60
K	4.60	5.00
All Dimensions in mm		



### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 25.3 grams (approx.)
- Mounting Position: Any
- Marking: Type Number

### Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	B40C5000/ 3300	B80C5000/ 3300	B125C5000/ 3300	B250C5000/ 3300	B380C5000/ 3300	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$						V	
Working Peak Reverse Voltage	$V_{RWM}$	100	200	300	600	900	V	
DC Blocking Voltage	$V_R$						V	
Recommend Input Voltage	$V_{RMS}$	40	80	125	250	380	V	
Average Rectified Output Current @ $T_A = 45^\circ\text{C}$ (Note 1)	$I_O$	5.0						A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	250						A
Repetitive Peak Forward Surge Current	$I_{FRM}$	30						A
Forward Voltage (per element) @ $I_F = 5.0\text{A}$	$V_{FM}$	1.1						V
Peak Reverse Current @ $T_C = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_C = 150^\circ\text{C}$	$I_R$	10 6.0						$\mu\text{A}$ mA
Rating for Fusing ( $t < 8.3\text{ms}$ ) (Note 2)	$I_t^2$	312						$\text{A}^2\text{s}$
Operating and Storage Temperature Range	$T_j, T_{STG}$	-55 to +150						$^\circ\text{C}$

**\*Glass Passivated forms are available upon request.**

Note: 1. Measured at 200cm<sup>2</sup> chassis, C-load,  $T_A = 45^\circ\text{C}$ .  
2. Non-repetitive for  $t > 1\text{ms}$  and  $< 8.3\text{ms}$ .

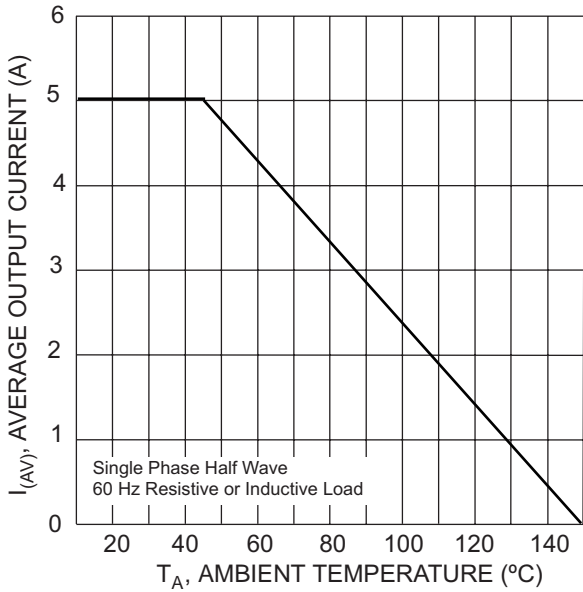


Fig. 1 Forward Current Derating Curve

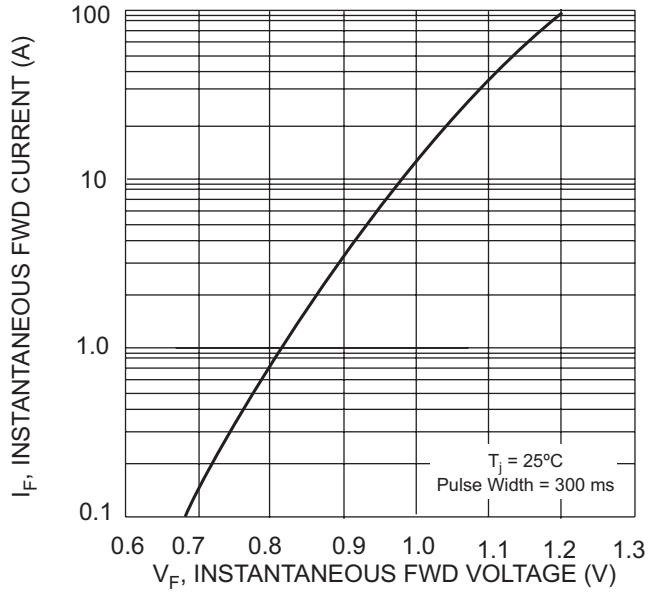


Fig. 2 Typical Forward Characteristics, per element

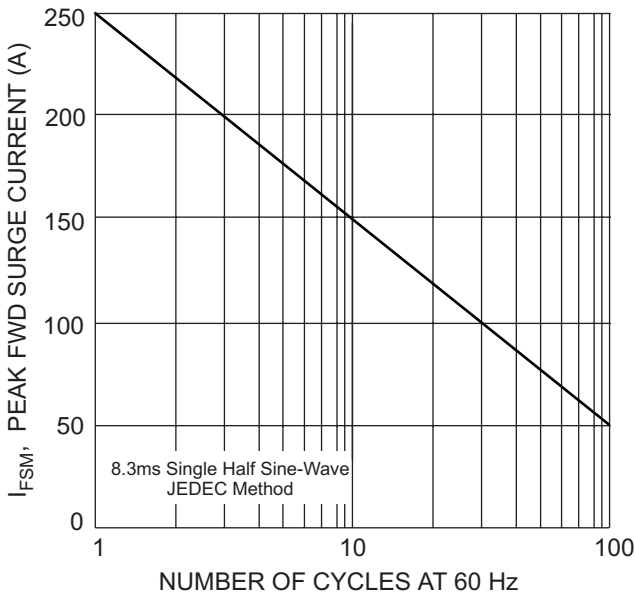


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

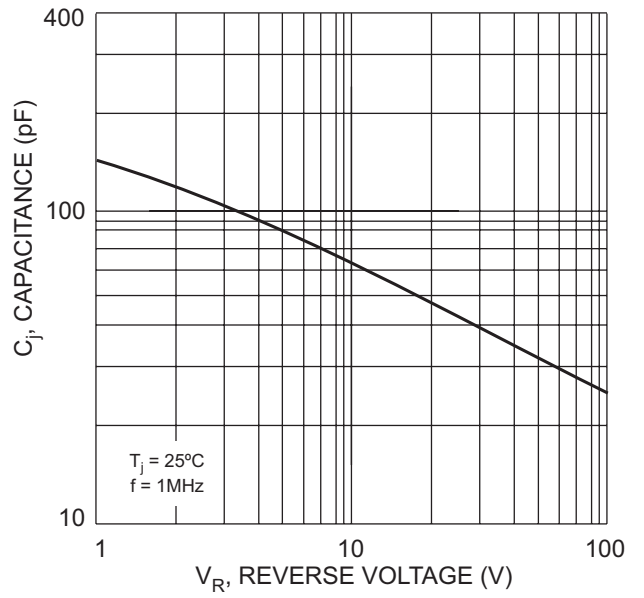


Fig. 4 Typical Junction Capacitance Per Element

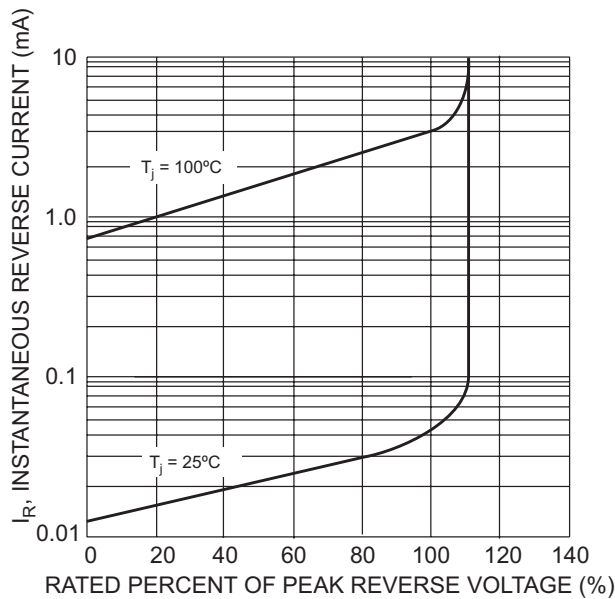


Fig. 5 Typical Reverse Characteristics

## ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
B40C5000/3300	SIL Bridge	200 Units/Box
B80C5000/3300	SIL Bridge	200 Units/Box
B125C5000/3300	SIL Bridge	200 Units/Box
B250C5000/3300	SIL Bridge	200 Units/Box
B380C5000/3300	SIL Bridge	200 Units/Box

Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.

Won-Top Electronics Co., Ltd (WTE) has checked all information carefully and believes it to be correct and accurate. However, WTE cannot assume any responsibility for inaccuracies. Furthermore, this information does not give the purchaser of semiconductor devices any license under patent rights to manufacturer. WTE reserves the right to change any or all information herein without further notice.

**WARNING:** DO NOT USE IN LIFE SUPPORT EQUIPMENT. WTE power semiconductor products are not authorized for use as critical components in life support devices or systems without the express written approval.

**Won-Top Electronics Co., Ltd.**

No. 44 Yu Kang North 3rd Road, Chine Chen Dist., Kaohsiung, Taiwan

**Phone:** 886-7-822-5408 or 886-7-822-5410

**Fax:** 886-7-822-5417

**Email:** sales@wontop.com

**Internet:** <http://www.wontop.com>

*We power your everyday.*